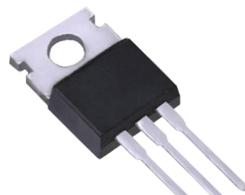


9A, 700V N-CHANNEL POWER MOSFET

■ DESCRIPTION

The **UTC 9N70** is a high voltage and high current power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.



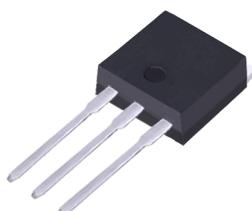
TO-220

■ FEATURES

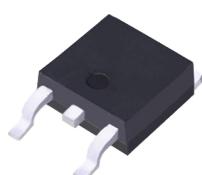
- * $R_{DS(ON)} < 1.3\Omega @ V_{GS} = 10V$
- * Low gate charge (typical 44 nC)
- * Low C_{RSS} (typical 10 pF)
- * High switching Speed
- * 100% avalanche tested
- * Improved dv/dt capability



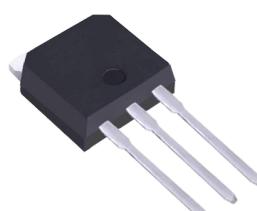
TO-220F



TO-262



TO-263



TO-251



TO-252

■ ABSOLUTE MAXIMUM RATINGS

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V_{DSS}	700	V
Gate-Source Voltage			V_{GSS}	± 30	V
Drain Current	Continuous $V_{GS} @ 10V$	$T_C=25^\circ C$ $T_C=100^\circ C$	I_D	9 5	A
	Pulsed (Note 2)			40	A
	Avalanche Current		I_{AR}	9	A
Avalanche Energy	Single Pulsed (Note 3)		E_{AS}	305	mJ
	Repetitive		E_{AR}	9	mJ
Power Dissipation ($T_C=25^\circ C$)		TO-220 TO-220F	P_D	156 44	W
Linear Derating Factor				1.25	
Junction Temperature		T_J		+150	°C
Storage Temperature		T_{STG}		-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by safe operating area.

3. Starting $T_J=25^\circ C$, $V_{DD}=50V$, $L=6.8mH$, $R_G=25\Omega$, $I_{AS}=9A$.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambien	TO-220	θ_{JA}	62	°C/W
	TO-220F		62.5	
Junction to Case	TO-220	θ_{JC}	0.8	°C/W
	TO-220F		2.86	

■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=1\text{mA}, V_{GS}=0\text{V}$	700			V
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Reference to 25°C , $I_D=1\text{mA}$		0.6		$^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=700\text{V}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$		10		μA
		$V_{DS}=560\text{V}, V_{GS}=0\text{V}, T_J=125^\circ\text{C}$		100		μA
Gate- Source Leakage Current	Forward	$V_{GS}=+30\text{V}$			+100	nA
	Reverse	$V_{GS}=-30\text{V}$			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2		4	V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=10\text{V}, I_D=4.5\text{A}$		1.1	1.25	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$		1500		pF
Output Capacitance	C_{OSS}			130		pF
Reverse Transfer Capacitance	C_{RSS}			10		pF
SWITCHING PARAMETERS						
Total Gate Charge (Note 2)	Q_G	$V_{GS}=10\text{V}, V_{DS}=560\text{V}, I_D=9\text{A}$		44		nC
Gate to Source Charge	Q_{GS}			11		nC
Gate to Drain Charge	Q_{GD}			12		nC
Turn-ON Delay Time (Note 2)	$t_{D(\text{ON})}$	$V_{DD}=350\text{V}, I_D=9\text{A}, R_G=10\Omega,$ $V_{GS}=10\text{V}, R_D=38\Omega$		19		ns
Rise Time	t_R			21		ns
Turn-OFF Delay Time	$t_{D(\text{OFF})}$			56		ns
Fall-Time	t_F			24		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S	$V_D=V_G=0\text{V}, V_S=1.5\text{V}$			9	A
Maximum Body-Diode Pulsed Current (Note 1)	I_{SM}				40	A
Drain-Source Diode Forward Voltage (Note 2)	V_{SD}	$I_S=9\text{A}, V_{GS}=0\text{V}, T_J = 25^\circ\text{C}$			1.5	V

Notes: 1. Pulse width limited by safe operating area.

2. Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.